

New Product

Dual P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
	$0.025 \text{ at V}_{GS} = -10 \text{ V}$	- 9.4		
- 30	0.030 at V _{GS} = - 4.5 V	- 8.6		
	0.045 at V _{GS} = - 2.5 V	- 7.0		

FEATURES

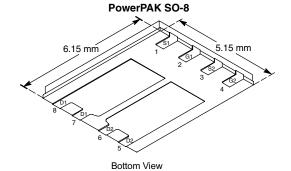
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile



COMPLIANT

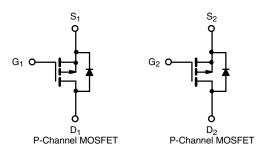
APPLICATIONS

- 1-2 Cell Li-Ion Battery Switch
- Bus Load Switch for Notebook/Desktop Computers



Ordering Information: Si7943DP-T1

Si7943DP-T1—E3 (Lead (Pb)-free)



ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted					
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 30		V
Gate-Source Voltage		V_{GS}	± 12		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	- 9.4	- 6.0	
Continuous Diain Current (1 j = 150 °C)	T _A = 70 °C		– 7.5	- 4.8	Α
Pulsed Drain Current		I _{DM}	- 30		^
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.9	- 1.2	
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	3.5	1.4	W
Maximum Fower Dissipation	T _A = 70 °C		2.2	0.9	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum lumation to Ambrianti	t ≤ 10 sec	R _{thJA}	26	35	°C/W
Maximum Junction-to-Ambient ^a	Steady State		60	85	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	2.2	2.7	

a. Surface Mounted on 1" x 1" FR4 Board.

a. Surface Mothled of 11 x 1 PA4 Board.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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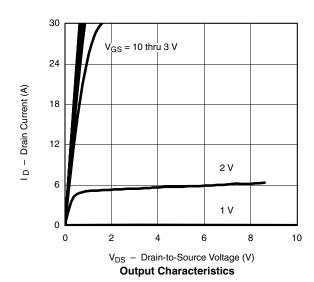


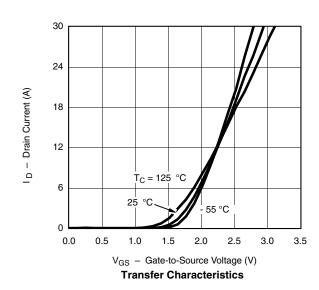
SPECIFICATIONS $T_J = 25$	°C, unless	otherwise noted				
Parameter	Symbol	Test Condition Min		Тур	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.60		- 1.5	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	1	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			– 1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 5	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			Α
		$V_{GS} = -10 \text{ V}, I_D = -9.4 \text{ A}$		0.020	0.025	Ω
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -8.6 \text{ A}$		0.024	0.030	
		$V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$		0.037	0.045	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -15 \text{ V}, I_{D} = -9.4 \text{ A}$		15		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.2	V
Dynamic ^b						
Total Gate Charge	Q_g			24	36	
Gate-Source Charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -9.4 \text{ A}$		8.5		nC
Gate-Drain Charge	Q _{gd}			5.0		
Gate Resistance	R_g			2.9		Ω
Turn-On Delay Time	t _{d(on)}			18	27	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_L = 15 \Omega$		40	60	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 6 \Omega$		100	150	ns
Fall Time	t _f			60	90	
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -2.9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		50	90	

Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

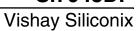
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted





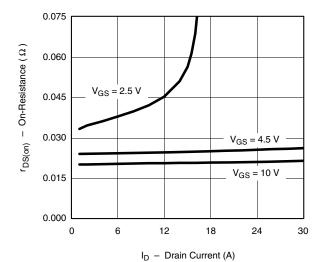




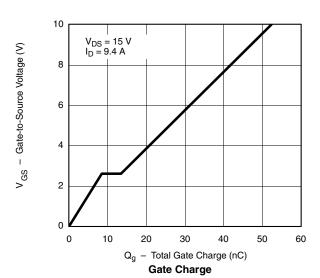


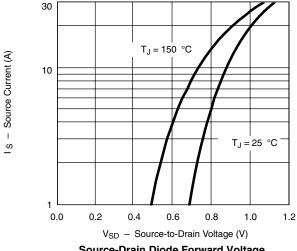
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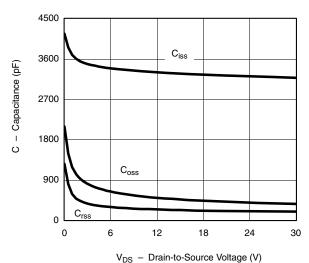


On-Resistance vs. Drain Current



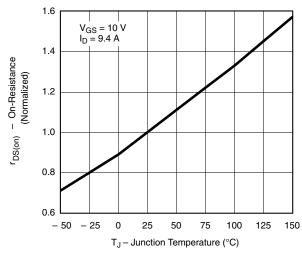


Source-Drain Diode Forward Voltage

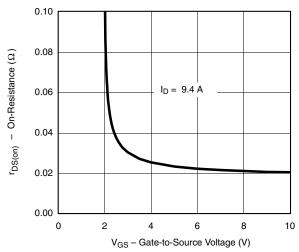


Capacitance





On-Resistance vs. Junction Temperature



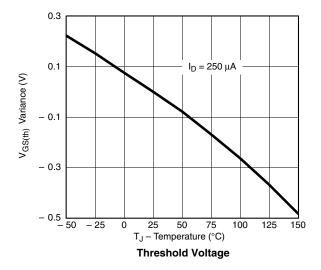
On-Resistance vs. Gate-to-Source Voltage

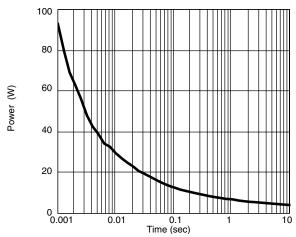
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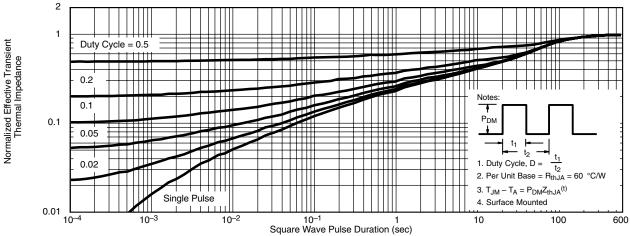


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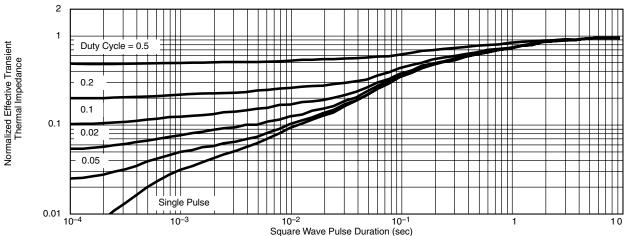




Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71629.



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